OP \$40.00 1220

PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Eun Jong SHIN	09/03/2008

RECEIVING PARTY DATA

Name:	Dongbu HiTek Co., Ltd.	
Street Address:	891-10 Daechi-dong, Gangnam-gu	
City:	Seoul	
State/Country:	KOREA, REPUBLIC OF	
Postal Code:	135-280	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12204720

CORRESPONDENCE DATA

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Correspondent Name: Andrew D. Fortney

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ATTORNEY DOCKET NUMBER:	A2007-S1154US
NAME OF SUBMITTER:	Andrew D. Fortney, Reg. No. 34 600

Total Attachments: 1

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PATENT REEL: 021491 FRAME: 0308

500640137

Attorney Docket No.: SPO200805-0032US

ASSIGNMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, I, the undersigned, **Eun Jong SHIN**

who have created a certain invention for which an application for United States Letters Patent was executed by me concurrently herewith and entitled:

Semiconductor Device and Method for Manufacturing Semiconductor Device

Do nereby sell, assign and transfer to Dongbu Hilek Co., Ltd.	, a corporation
of Republic of Korea	, having a place of business
at 891-10, Daechi-dong, Gangnam-gu, Seoul 135-280 / Republic of Ko	
its successors, assigns, and legal representatives, the full and exclusive application and to any and all inventions described in said application possessions and all foreign countries, and the entire right, title and interest which may be granted therefor in the United States, its territorial possession and to any and all continuations-in-part, continuations, divisions, substitutes other applications for Letters Patent relating thereto which have been or starritorial possessions and/or any foreign countries, and all rights, together the international conventions, unions, agreements, acts, and treaties, includagreements, acts, and treaties;	for the United States, its territorial tin and to any and all Letters Patent ons and all foreign countries; and in s, reissues, extensions thereof, and all hall be filed in the United States, its with all priority rights, under any of
To a strong to control to	
apply for and receive Letters Patent for said invention and said invention invention, in its own name, in the United States, its territorial possessions when requested to carry out in good faith the intent and purpose of this Assignee, its successors, assigns and legal representatives, the undersigner part, continuations, divisions, substitutes, reissues, extensions thereof, exergive powers of attorney and other papers, testify in any legal or quasi legal Assignee, its successors, assigns or legal representatives all facts known invention and the history thereof; and generally do everything possible wassigns, or legal representatives shall consider desirable for aiding in securing patent protection for said invention and for vesting title to said invention and invention in said Assignee, its successors, assigns, or legal representatives; and invention in said Assignee, its successors, assigns, or legal representatives; and invention in said Assignee, its successors, assigns, or legal representatives; and invention in said Assignee, its successors, assigns, or legal representatives; and invention in said Assignee, its successors, assigns, or legal representatives; and invention in said Assignee, its successors, assigns, or legal representatives; and invention in said Assignee.	s, and all foreign countries; and that, a assignment, at the expense of said ed will execute all continuations-in- ceute all rightful oaths, assignments, a proceedings; communicate to said a to the undersigned relating to said which said Assignee, its successors, and maintaining and enforcing proper and all applications for patents on said and
Covenant with said Assignee, its successors, assigns, or legal represent mortgage, license or other agreement affecting the rights and property herein by the undersigned, and that full right to convey the same as herein expresses.	in conveyed has been made to others
IN TESTIMONY WHEREOF I have hereunto set MY signature on the date	indicated below.
Full Name of Sole/First Inventor:	
Eun Jong SHIN	
Inventor's Signature: Date	e: Month/Day/Year
S. S	2p/3/2009
Full Name of Second Inventor, if any:	
Inventor's Signature: Date	e: Month/Day/Year

Customer No. 36872

RECORDED: 09/05/2008

PATENT REEL: 021491 FRAME: 0309